To

ENEE236
Analog Electronics

Instructor

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Main Reference1 (~ text book) : **Electronic Devices and Circuit Theory , 10th Edition by R. Boylestad & L. Nashelsky**

Main Reference 2: **Electronic Devices, 8th edition, by Floyd**

Course Objectives

- Study diode construction, basic operating principles and modeling.
- To analyze and design diode based circuits used in different application such as ac-dc rectifiers, limiting and clamping, voltage multiplication.
- To Study zener diode operation and usage as voltage regulator.
- To Study construction, operation, biasing of Bipolar Junction Transistors and Field Effect Transistors.
- To design and analyze BJT and FET based amplifier circuits using small signal analysis techniques including their high and low frequency response
- To study operational amplifiers and how to use them in various applications such as amplification, summation, comparison, integration, differentiation
- To study different discrete and integrated circuit Voltage Regulators and be able to design them for different applications

ENEE236 – Analog Electronics

Course Contents

1. Introduction to Semiconductors and Semiconductor diodes
   - Atomic Structure; Semiconductors , Conductors And Insulators; Covalent Bonds;
   - Conduction in Semiconductors; N-Type and P-Type Semiconductors
   - The diode; biasing a Diode; V-I Characteristics of a Diode; Diode Models

2. Diode Applications
   - Load Line Analysis, Half-Wave and Full-Wave Rectifiers; Power supply Filters and Regulators; Diode Limiting and Clamping Circuits; Voltage Multipliers; The diode Data Sheet, Zener Diodes and their Applications

3. Bipolar Junction Transistors (BJT)
   - Transistor construction and operation, Transistor Characteristics and Parameters; The Transistor as an Amplifier; The Transistor as a Switch.

4. DC Biasing of BJTs

The DC Operating Point (Quiescent Operating Point); Voltage-Divider Bias; Other Bias Methods.

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Course Contents

5. BJT AC Analysis

Amplifiers and small signal analysis, Transistor AC Equivalent Circuits- Hybrid Parameters, Common-Emitter Amplifier; Common-Collector Amplifier; Common-Base Amplifier; Multistage Amplifiers.

6. Field-Effect Transistors (FETs)

The JFET; JFET Characteristics and Parameters; JFET Biasing; The MOSFET Characteristics and Parameters; MOSFET Biasing

7. FET Amplifiers.

FET Amplification; Common-Source Amplifiers; Common- Drain Amplifiers and Common-Gate Amplifiers;

8. Operational Amplifiers and Applications

Introduction to Operational Amplifiers; Op-Amp Input Modes and Parameters Negative Feedback; Op-Amps with Negative Feedback ; Comparators; Summing Amplifiers; Integrators and Differentiators.
Instrumentation Amplifier; Converters and Other Op-Amp Circuits.

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Course Contents

9. Amplifier Frequency Response
Basic Concepts; The Decibel; Low-Frequency Amplifier Response.
High- Frequency Amplifier Response; Total Amplifier Frequency Response.

10. Voltage Regulators
Voltage Regulation; Basic Series Regulator; Basic shunt Regulator; Integrated Circuit Voltage Regulators.

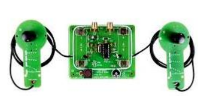
Grading Policy

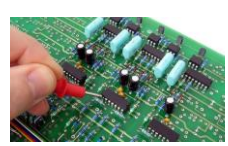
Quizes	15%
Projects	15%
Midterm Exam	30%
Final Exam	40%

Introduction to Semiconductors and Semiconductor Diodes

Electronics Circuits

- We encounter electronics in our daily life in form of telephones, radios, television, audio equipment, home appliances, computer and equipment for industrial control and automation .



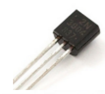


- The field of electronics deals with the design and application of electronic design .

Electronics Devices

- Diodes
  - a) Rectifier diode
  - b) Zener diode
  - c) Light Emitting Diode (LED)

- Transistors
  - a) Bipolar Junction Transistor (BJT)
  - b) Field Effect Transistor (FET)

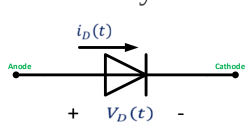


- Integrated Circuits (IC)
  - a) Operational Amplifier (OpAmps)
  - b) Voltage Regulators

Diode

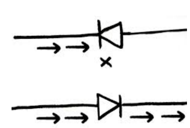
- It is an electronic device with a single p-n junction and it has the ability to conduct current in one direction while blocking current in the other direction.

- Circuit Symbol :



Example Component

- Physical constriction



Diode

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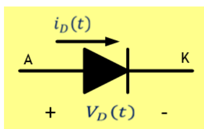
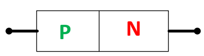
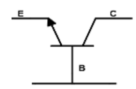
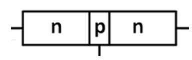


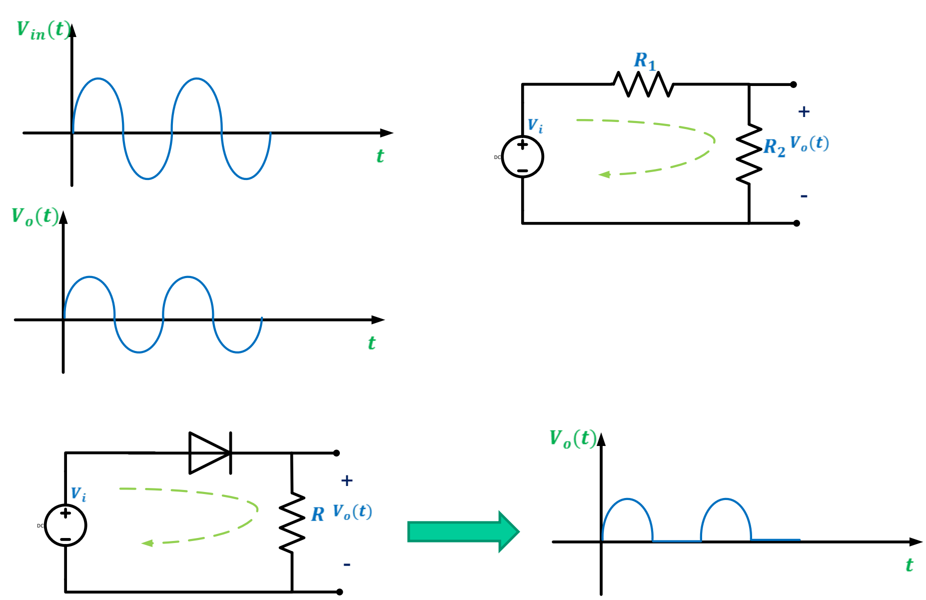
- Physical construction



Physical construction of the npn BJT







Semiconductors

- Electronic devices as diodes, transistors and integrated circuits are made of semiconductor material .

- Semiconductors : materials whose resistance lies between low resistance of conductor and the high resistance of insulator .

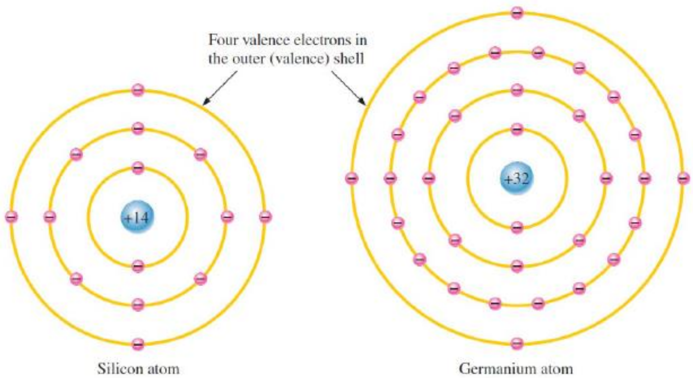
Materials can be classified by their ability to conduct electricity.

1 - Conductors : Materials that easily conduct electrical current

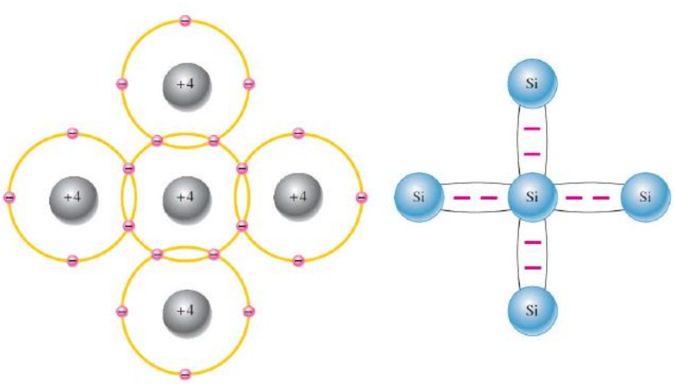
2 – Insulators : Materials that do not conduct electrical current under normal condition

3 – Semiconductors: Material that are between conductors and insulators in their ability to conduct electrical current

Atomic structure



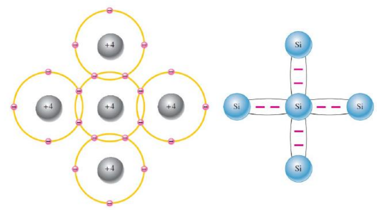
Covalent bond



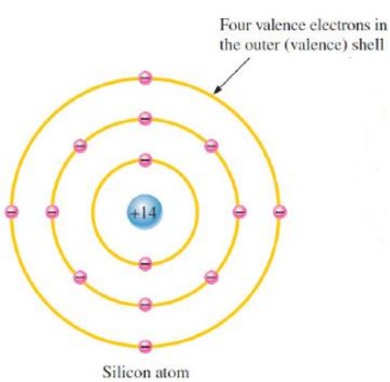
Covalent bond

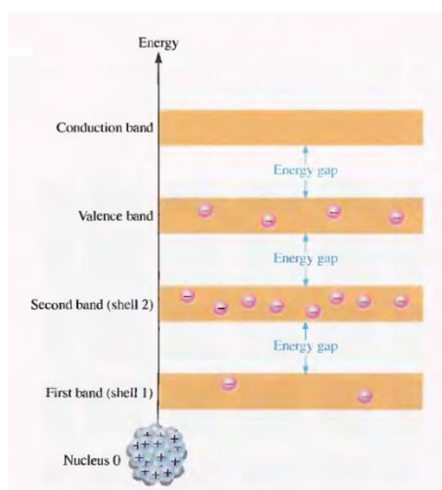
- A silicon (Si) atom with its four valence electrons shares an electron with each of its four neighbors
- This effectively creates eight shared valence electrons for each atom and produces a state of chemical stability .

- Also, this sharing of valence electrons produce the covalent bonds that hold the atom together; each valence electron is attracted equally by the two adjacent atoms which share it .



Conduction in Semiconductors

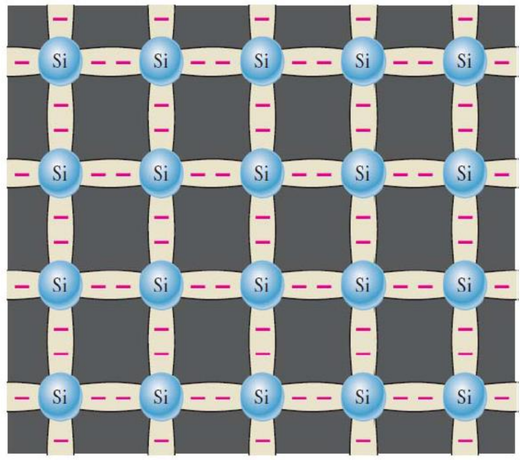




Energy Band Diagram for an unexcited Si atom

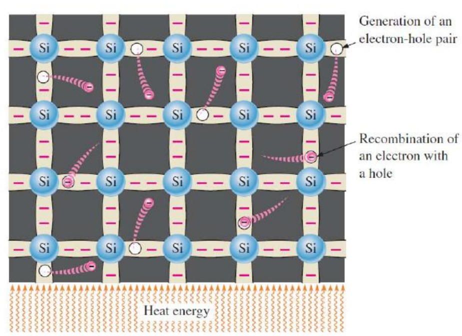
Covalent bond in silicon crystals

- At absolute zero degree (-273 C^o) all valence electrons are tightly bonded to their atoms and there is no free electrons, so the silicon behave as an insulator .



Rupture of the a covalent bond

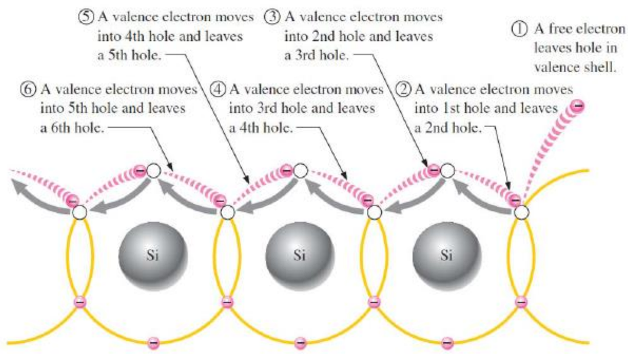
- When an electron becomes free that is unattached to any atom, a vacancy is left in the valence band within the crystal . This vacancy is called hole .
- For every free electron, there is one hole .
- One broken covalent bond → one free electron + one hole
  - At room temperature there is one broken covalent bond for every $3x10^{12}$ pure Si atoms .



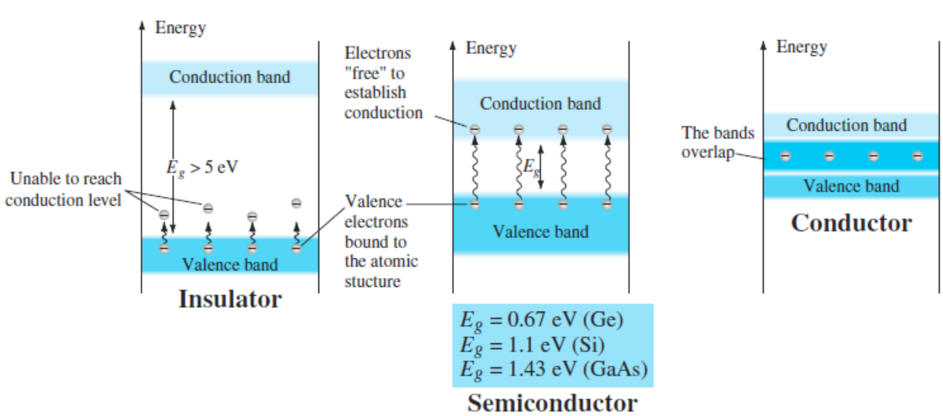
- At room temperature there are few available charge carriers (free electrons + holes)

Hole motion

- When a valence electron moves left to right to fill a hole while leaving another hole behind, the hole has effectively moved from right to left.



Energy Gap



(b)

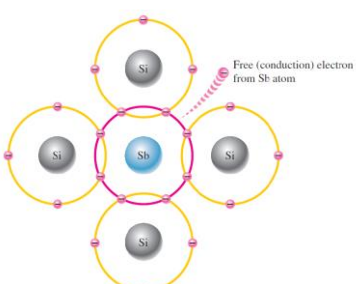
Doping

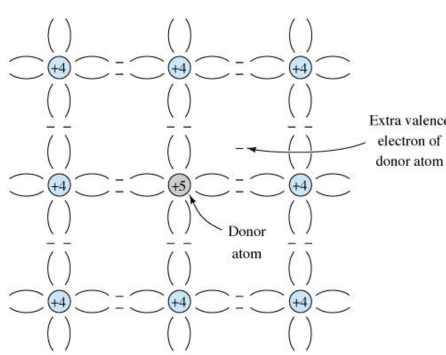
- A manufacturing process that adds free charge carriers (free electron or hole) into a pure semiconductor material to increase its conductivity
- There is two categories of impurities: n-type or p-type

- **N-Type Semiconductor**
- Pentavalent impurity (one which has 5 valence electrons) atom is added such as phosphorus
- This atom forms covalent bonds with 4 adjacent silicon atoms, while the fifth becomes a conduction electron since it is not attached to any atom

n-type silicon

n-type silicon is created by adding valence five impurity atoms.

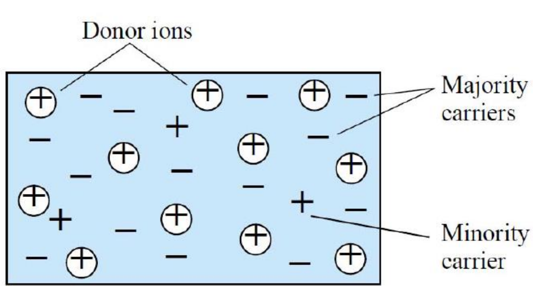




With the number of electrons increasing, the rate of recombination between free electrons and holes also increase

- Number of conduction electrons can be carefully controlled by the number of impurities added
- Since most of the current carriers are electrons, this type of material doped with pentavalent impurities is an n-type semiconductor
- The majority current carriers in n-type material is electrons, but there are few holes created when electron-hole pair are thermally generated, these holes are minority carriers

In the n-type material the free electrons are the majority and the holes are the minority.

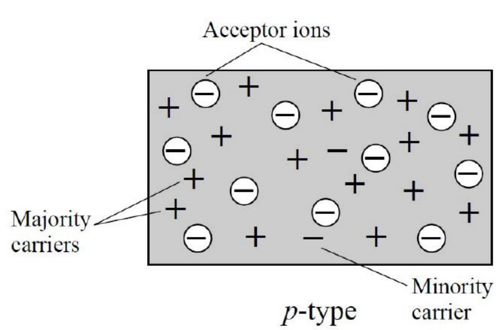


n-type

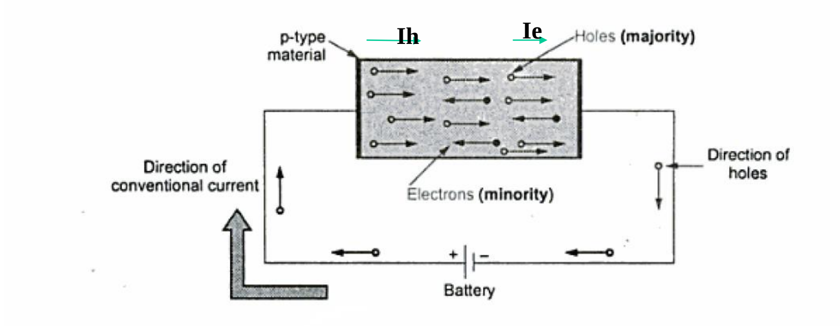
P-Type Semiconductor

- To increase number of holes in intrinsic silicon, trivalent impurity atoms are added (atoms with three valence electrons) such as boron (B) or gallium (Ga)
- Valence electrons (3) of the impurity atom create covalent bonds with three adjacent atoms of silicon and a fourth electron is missing, creating a hole with each added impurity atom
- Majority carriers in P-type material are holes
- Also there are few free electrons that are created when electron-hole pair are thermally generated, these electrons are minority carriers

In the p-type material the holes are the majority and the free electro ns are the minority .

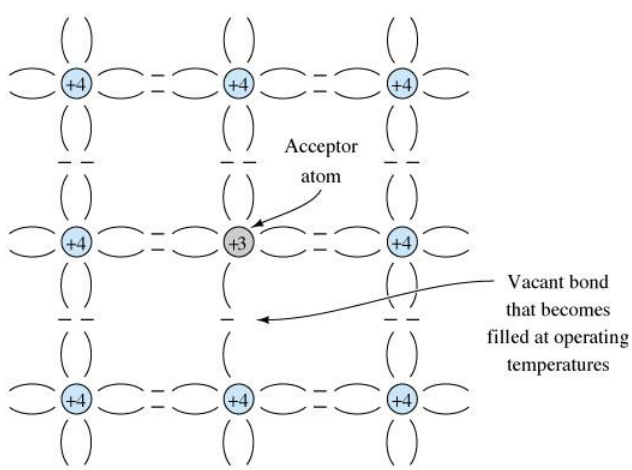


Conduction in p-type material



Conduction in p-type material

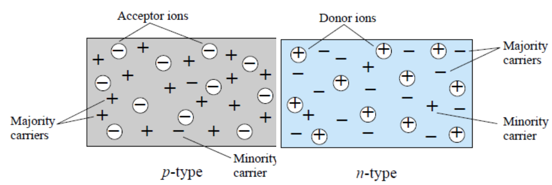
p-type silicon

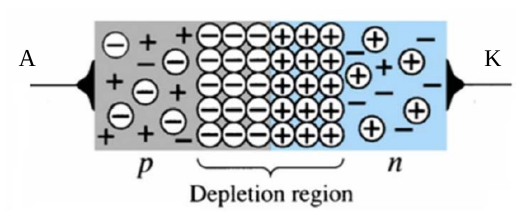


p-type silicon is created by adding valence three impurity atoms.

Pn junction

The p- n junction is the basis for diodes, certain transistors ,and other devices.





Formation of Depletion Region

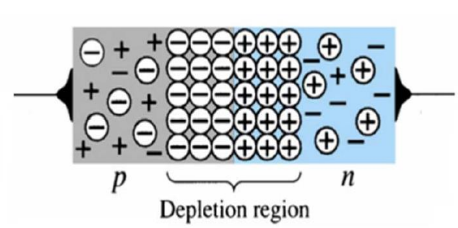
1) Electrons from the n-type material near the junction diffuse a cross the junction.

2) These electrons fill the holes in the p-type material adjacent to the junction.

3) As a result of electrons leaving the n-type material , **donor ions are created** on the n side of the junction .

4) When these electrons fill holes in the p side of the junction , **accepter ions** are produced.

5) A wall of stationary positive ions is aligned with a wall of n egative ions along the n and p sides of the junction .



6) The space occupied between the ion walls is called depletion region.

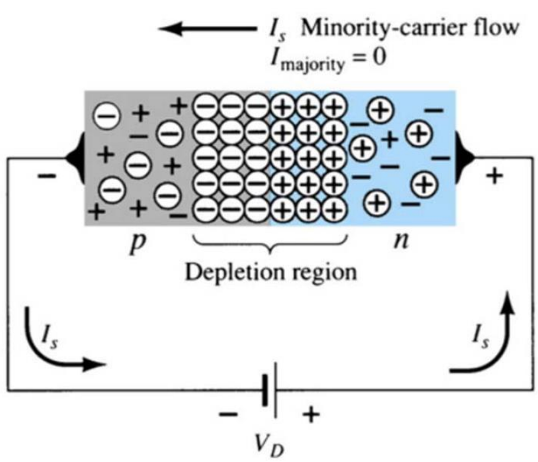
7)Whenever there exists a positive charge with respect to a negative charge , a voltage difference is set between charges ;(Junction potential, Junction barrier).

8) The junction potential acts as potential barrier that tend to prevent majority carriers from crossing the junction.

9) Minority carriers are aided by the junction potential .

Reverse bias of a pn junction

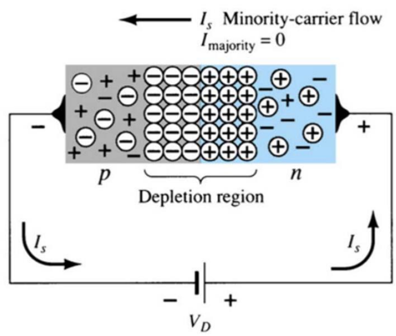
Reverse bias is when the voltage at the n-side is higher than p-side



▶The reverse voltage causes the depletion region to widen .

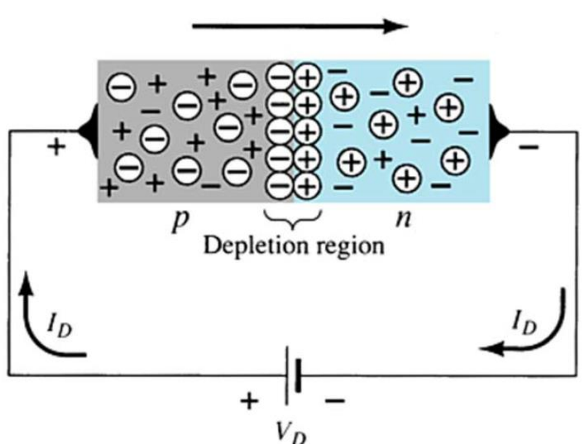
▶The electrons in the n-type material are attracted toward the positive terminal of the voltage source .

▶The holes in the p-type material are attracted toward the negative terminal of the voltage source .

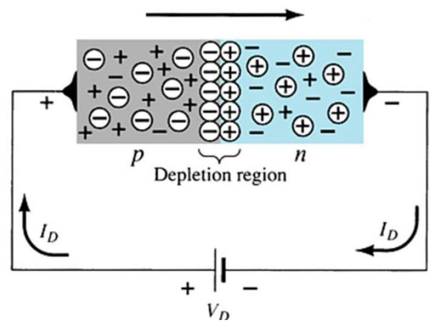


Forward bias of a pn junction

Forward bias is when the voltage at the p-side is higher than n-side



- ►The forward voltage causes the depletion region to narrow
- ►The electrons and holes are pushed toward the p-n junction
- ►The electrons and holes have sufficient energy to cross the p-n junction



https://www.youtube.com/watch?v=OsfguONJw2Q

https://www.youtube.com/watch?v=ar7xDMR4P_U